- **Members of the Texas Instruments *Widebus*™ Family**
- **State-of-the-Art *EPIC*-IIB™ BiCMOS Design Significantly Reduces Power Dissipation**
- **Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17**
- **Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25°C**
- **Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise**
- **Flow-Through Architecture Optimizes PCB Layout**
- **High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})**
- **Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

SN54ABT16470 . . . WD PACKAGE
SN74ABT16470 . . . DGG OR DL PACKAGE
(TOP VIEW)

1$\overline{OEAB}$	1		56	1$\overline{OEBA}$
1CLKAB	2		55	1CLKBA
1$\overline{CLKENAB}$	3		54	1$\overline{CLKENBA}$
GND	4		53	GND
1A1	5		52	1B1
1A2	6		51	1B2
V_{CC}	7		50	V_{CC}
1A3	8		49	1B3
1A4	9		48	1B4
1A5	10		47	1B5
GND	11		46	GND
1A6	12		45	1B6
1A7	13		44	1B7
1A8	14		43	1B8
2A1	15		42	2B1
2A2	16		41	2B2
2A3	17		40	2B3
GND	18		39	GND
2A4	19		38	2B4
2A5	20		37	2B5
2A6	21		36	2B6
V_{CC}	22		35	V_{CC}
2A7	23		34	2B7
2A8	24		33	2B8
GND	25		32	GND
2$\overline{CLKENAB}$	26		31	2$\overline{CLKENBA}$
2CLKAB	27		30	2CLKBA
2$\overline{OEAB}$	28		29	2$\overline{OEBA}$

description

The 'ABT16470 are 16-bit registered transceivers that contain two sets of D-type flip-flops for temporary storage of data flowing in either direction. The 'ABT16470 can be used as two 8-bit transceivers or one 16-bit transceiver. Separate clock (CLKAB or CLKBA) and output-enable ($\overline{OEAB}$ or $\overline{OEBA}$) inputs are provided for each register to permit independent control in either direction of data flow.

To avoid false clocking of the flip-flops, clock enable ($\overline{CLKEN}$) should not be switched from high to low while CLK is high.

To ensure the high-impedance state during power up or power down, $\overline{OE}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16470 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT16470 is characterized for operation from –40°C to 85°C.

Widebus and EPIC-IIB are trademarks of Texas Instruments Incorporated.

Copyright © 1997, Texas Instruments Incorporated

TEXAS INSTRUMENTS

POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265

FUNCTION TABLE[†]

INPUTS				OUTPUT B
$\overline{\text{CLKENAB}}$	CLKAB	$\overline{\text{OEAB}}$	A	
H	X	X	X	Z
X	X	H	X	Z
L	L	L	X	B_0[‡]
L	↑	L	L	L
L	↑	L	H	H

[†] A-to-B data flow is shown: B-to-A flow is similar but uses $\overline{\text{CLKENBA}}$, CLKBA, and $\overline{\text{OEBA}}$.

[‡] Output level before the indicated steady-state input conditions were established

TEXAS INSTRUMENTS

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

logic symbol†

Pin	Input		Symbol
1OEBA	56		1EN3
1CLKENBA	54		G1
1CLKBA	55		1C5
1OEAB	1		2EN4
1CLKENAB	3		G2
1CLKAB	2		2C6
2OEBA	29		7EN9
2CLKENBA	31		G7
2CLKBA	30		7C11
2OEAB	28		8EN10
2CLKENAB	26		G8
2CLKAB	27		8C12

A	Pin					Pin	B
1A1	5	▽	1	5D		52	1B1
		6D	1	4▽			
1A2	6					51	1B2
1A3	8					49	1B3
1A4	9					48	1B4
1A5	10					47	1B5
1A6	12					45	1B6
1A7	13					44	1B7
1A8	14					43	1B8
2A1	15	▽	1	11D		42	2B1
		12D	1	10▽			
2A2	16					41	2B2
2A3	17					40	2B3
2A4	19					38	2B4
2A5	20					37	2B5
2A6	21					36	2B6
2A7	23					34	2B7
2A8	24					33	2B8

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

TEXAS
INSTRUMENTS

logic diagram (positive logic)
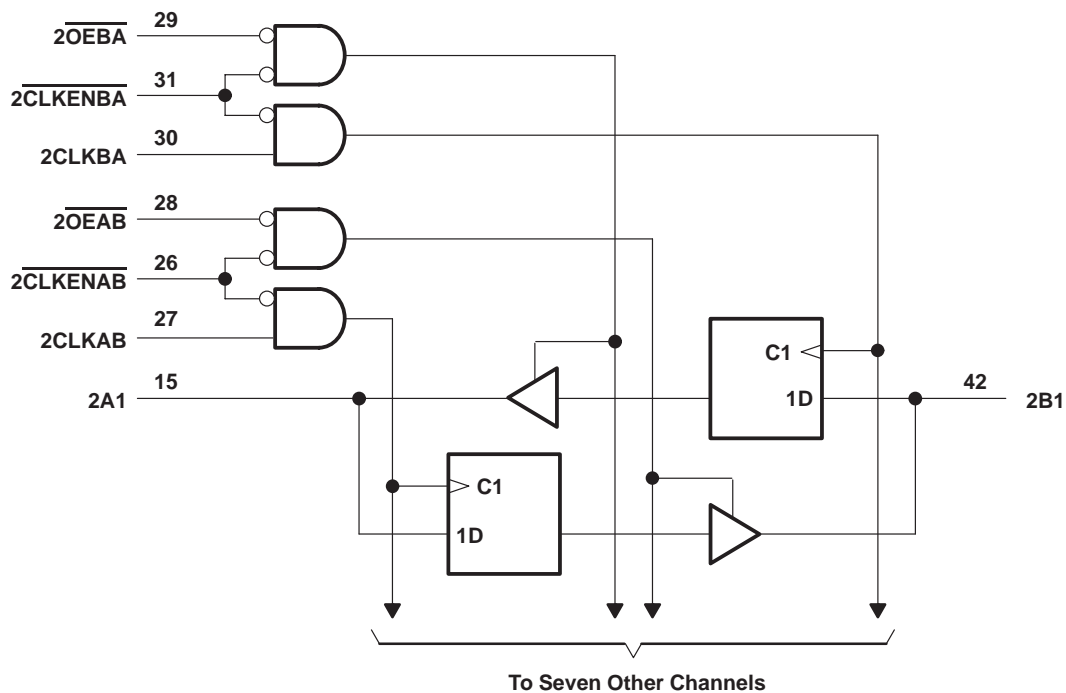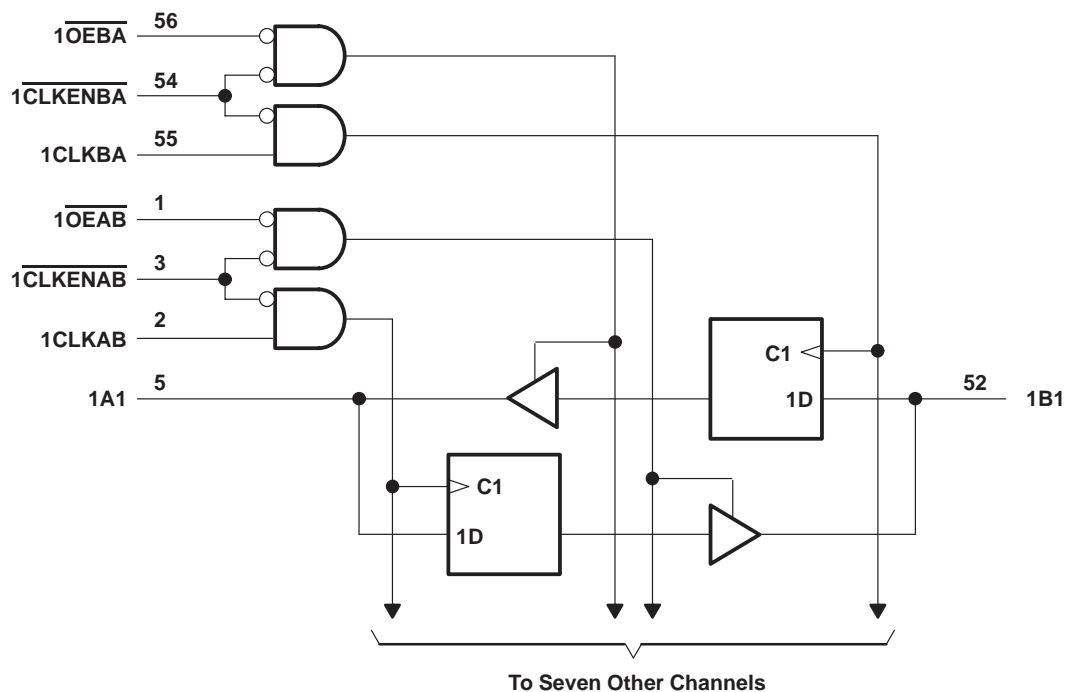
To Seven Other Channels

To Seven Other Channels

TEXAS
INSTRUMENTS
POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} .... –0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1) .... –0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, V_O .... –0.5 V to 5.5 V
Current into any output in the low state, I_O: SN54ABT16470 .... 96 mA
 SN74ABT16470 .... 128 mA
Input clamp current, I_{IK} ($V_I < 0$) .... –18 mA
Output clamp current, I_{OK} ($V_O < 0$) .... –50 mA
Package thermal impedance, θ_{JA} (see Note 2): DGG package .... 81°C/W
 DL package .... 74°C/W
Storage temperature range, T_{stg} .... –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

recommended operating conditions (see Note 3)

			SN54ABT16470		SN74ABT16470		UNIT
			MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage		4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage		2		2		V
V_{IL}	Low-level input voltage			0.8		0.8	V
V_I	Input voltage		0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current			–24		–32	mA
I_{OL}	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
T_A	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

TEXAS INSTRUMENTS

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		$T_A = 25°C$ MIN	TYP†	MAX	SN54ABT16470 MIN	MAX	SN74ABT16470 MIN	MAX	UNIT
V_{IK}		$V_{CC} = 4.5$ V,	$I_I = -18$ mA			−1.2		−1.2		−1.2	V
V_{OH}		$V_{CC} = 4.5$ V,	$I_{OH} = -3$ mA	2.5			2.5		2.5		V
		$V_{CC} = 5$ V,	$I_{OH} = -3$ mA	3			3		3		
		$V_{CC} = 4.5$ V	$I_{OH} = -24$ mA	2			2				
			$I_{OH} = -32$ mA	2*					2		
V_{OL}		$V_{CC} = 4.5$ V	$I_{OL} = 48$ mA			0.55		0.55			V
			$I_{OL} = 64$ mA			0.55*				0.55	
V_{hys}					100						mV
I_I	Control inputs	$V_{CC} = 5.5$ V,	$V_I = V_{CC}$ or GND			±1		±1		±1	μA
	A or B ports					±100		±100		±100	
I_{OZH}‡		$V_{CC} = 5.5$ V,	$V_O = 2.7$ V			50		50		50	μA
I_{OZL}‡		$V_{CC} = 5.5$ V,	$V_O = 0.5$ V			−50		−50		−50	μA
I_{off}		$V_{CC} = 0$,	V_I or $V_O \leq 4.5$ V			±100				±100	μA
I_{CEX}		$V_{CC} = 5.5$ V, $V_O = 5.5$ V	Outputs high			50		50		50	μA
I_O§		$V_{CC} = 5.5$ V,	$V_O = 2.5$ V	−50	−100	−200	−50	−200	−50	−200	mA
I_{CC}	A or B ports	$V_{CC} = 5.5$ V, $I_O = 0$, $V_I = V_{CC}$ or GND	Outputs high			2		2		2	mA
			Outputs low			35		35		35	
			Outputs disabled			2		2		2	
ΔI_{CC}¶		$V_{CC} = 5.5$ V, One input at 3.4 V, Other inputs at V_{CC} or GND				0.5		0.5		0.5	mA
C_i	Control inputs	$V_I = 2.5$ V or 0.5 V			3						pF
C_{io}	A or B ports	$V_O = 2.5$ V or 0.5 V			8.5						pF

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at $V_{CC} = 5$ V.

‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		$V_{CC} = 5$ V, $T_A = 25°C$ MIN	MAX	SN54ABT16470 MIN	MAX	SN74ABT16470 MIN	MAX	UNIT
f_{clock}	Clock frequency	0	150	0	150	0	150	MHz
t_w#	Pulse duration, CLKAB or CLKBA high or low	3.3		3.3		3.3		ns
t_{su}	Setup time, data before CLKAB↑ or CLKBA↑	4		4		4		ns
t_h	Hold time, data after CLKAB↑ or CLKBA↑	1		1		1		ns

\# This parameter is characterized, but not production tested.

![Texas Instruments logo]

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 5 V, T_A = 25°C			SN54ABT16470		SN74ABT16470		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			150			150		150		MHz
t_{PLH}	CLK	A or B	1.4	3.1	4.8	1.4	5.1	1.4	4.9	ns
t_{PHL}			1.3	3.2	4.6	1.3	5.1	1.3	4.9	
t_{PZH}	$\overline{OE}$	A or B	1	3.1	4.3	1	5	1	4.9	ns
t_{PZL}			1.2	3.6	5.8	1.2	6.9	1.2	6.8	
t_{PHZ}	$\overline{OE}$	A or B	1.9	3.7	4.9	1.9	6	1.9	5.5	ns
t_{PLZ}			1.6	3.3	4.8	1.6	5.4	1.6	5.3	
t_{PZH}	$\overline{CLKEN}$	A or B	1	3.4	4.6	1	5.8	1	5.7	ns
t_{PZL}			1.2	3.9	6	1.2	7.3	1.2	7.2	
t_{PHZ}	$\overline{CLKEN}$	A or B	1.7	3.9	5.2	1.7	6.2	1.7	5.8	ns
t_{PLZ}			1.5	3.6	5.3	1.5	5.5	1.5	5.4	

![Texas Instruments logo] **TEXAS INSTRUMENTS**

PARAMETER MEASUREMENT INFORMATION
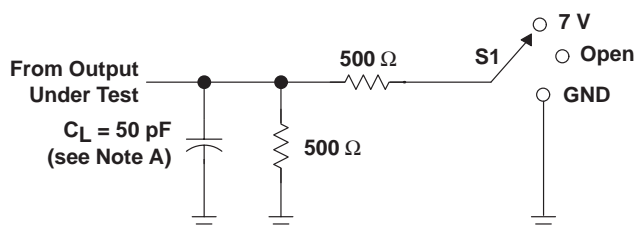
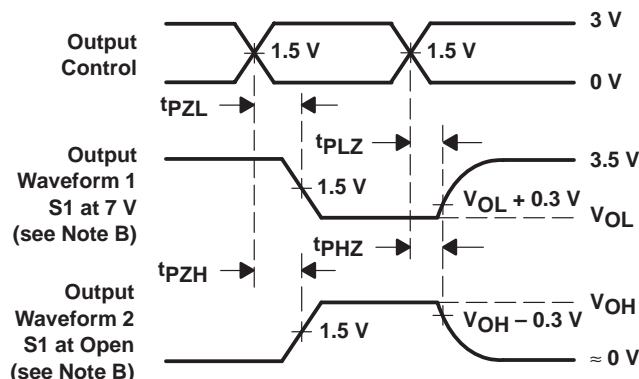| TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open

LOAD CIRCUIT
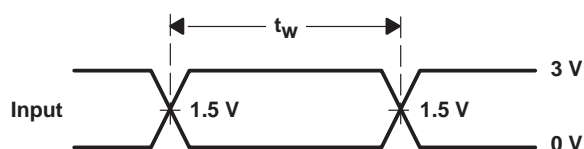
VOLTAGE WAVEFORMS
PULSE DURATION
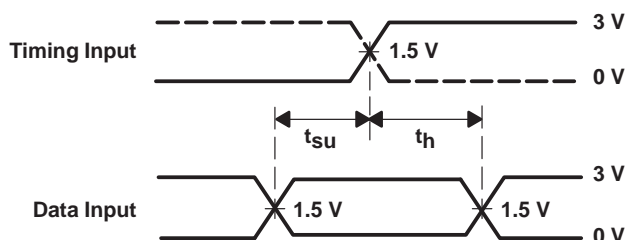
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES
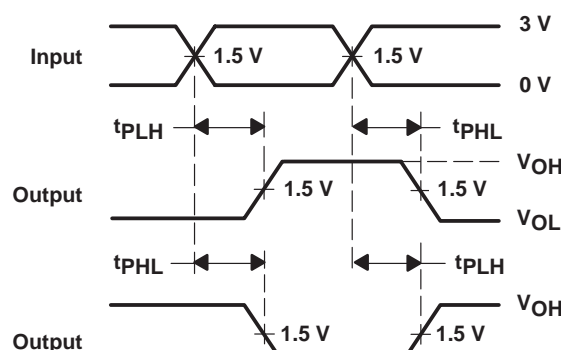
VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
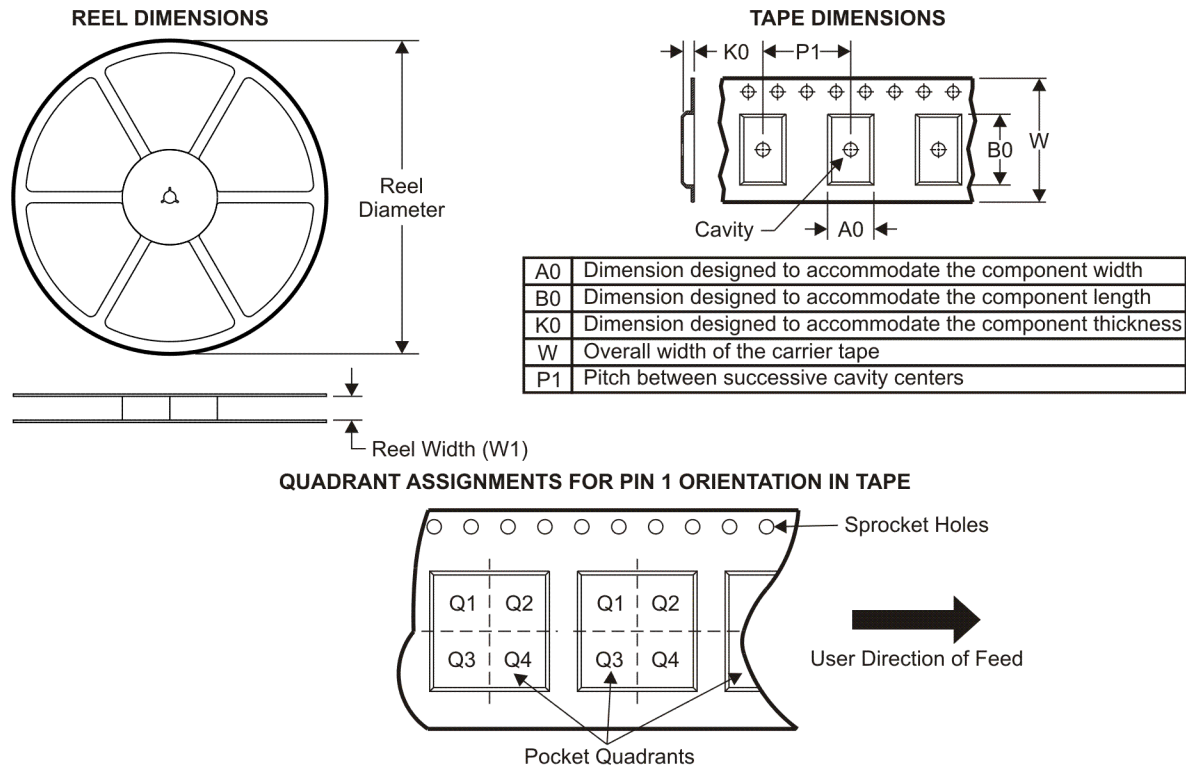**INVERTING AND NONINVERTING OUTPUTS**

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.
   B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
      Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
   D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

TAPE AND REEL INFORMATION

REEL DIMENSIONS

Reel Diameter

Reel Width (W1)

TAPE DIMENSIONS

K0 — P1

B0 — W

Cavity — A0

Sprocket Holes

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

Sprocket Holes

| Q1 | Q2 |
| Q3 | Q4 |

User Direction of Feed

Pocket Quadrants

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16470DGGR	TSSOP	DGG	56	2000	330.0	24.4	8.6	15.6	1.8	12.0	24.0	Q1
SN74ABT16470DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT16470DGGR	TSSOP	DGG	56	2000	346.0	346.0	41.0
SN74ABT16470DLR	SSOP	DL	56	1000	346.0	346.0	49.0

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		**Applications**	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Clocks and Timers	www.ti.com/clocks	Digital Control	www.ti.com/digitalcontrol
Interface	interface.ti.com	Medical	www.ti.com/medical
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
RFID	www.ti-rfid.com	Telephony	www.ti.com/telephony
RF/IF and ZigBee® Solutions	www.ti.com/lprf	Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265